

FD 11/7/2001

ISSUE CLASSIFICATION	
Class	Subclass

PATENT NUMBER

U.S. UTILITY Patent Application

<p>O.I.P.E.</p> <p>SCANNED <u>ACB</u> Q.A. <u>AA</u></p>	<p>PATENT DATE</p>
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APPLICATION NO. 09/926033	CONT/PRIOR D F pg 9/10	CLASS 522 430	SUBCLASS 281.1	ART UNIT 1711 1752	EXAMINER CLARKE
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Takeshi Ohashi
Chikara Ishikawa

Photosensitive resin composition, photosensitive element using the same, process for producing resist pattern, and process for producing printed wiring board

ISSUING CLASSIFICATION												
ORIGINAL				CROSS REFERENCE(S)								
CLASS		SUBCLASS		CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)							
INTERNATIONAL CLASSIFICATION												

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<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) (Date)		NOTICE OF ALLOWANCE MAILED	
	<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____		ISSUE FEE	
_____ (Primary Examiner) (Date)			Amount Due	Date Paid
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